

# SPLC 2016

The 20th International Systems and Software Product Line Conference:  
September 19th to 23rd, 2016 Beijing, China



## IMPORTANT DATES

<b>Abstract Submission:</b>	<b>March 7, 2016</b>
<b>Paper Submission:</b>	<b>March 14, 2016</b>
<i>Notification of Acceptance:</i>	April 25, 2016
<i>Camera-ready Paper Due:</i>	May 23, 2016
<i>Workshop Proposals:</i>	<b>March 7, 2016</b>
<i>Tutorial Proposals:</i>	May 16, 2016
<i>Tool Demonstrations:</i>	May 16, 2016
<i>Doctoral Symposium:</i>	May 16, 2016

### SPLC 2016 General Chair

Hong Mei, *Shanghai Jiao Tong University, China*

### Research Track Chairs

Rick Rabiser, *Johannes Kepler University Linz, Austria*  
Bing Xie, *Peking University, China*

### Software Industry Track Chairs

Christoph Elsner, *Siemens AG, Germany*  
Yun Xie, *Digital China, China*

### Systems Engineering Track Chairs

Krzysztof Czarnecki, *University of Waterloo, Canada*  
Bran Selic, *Malina Software Corp., Canada*

### Vision Track Chairs

Jesper Andersson, *Linnaeus University, Sweden*  
Antonio Ruiz Cortés, *University of Sevilla, Spain*

### Local Chair

Dan Hao, *Peking University, China*

### Hall of Fame Chairs

Goetz Botterweck, *Lero, Ireland*  
Natsuko Noda, *Shibaura Institute of Technology, Japan*

### Workshop Chairs

Andrzej Wasowski, *IT University, Denmark*  
Xin Peng, *Fudan University, China*

### Tutorial Chairs

Jocelyn Simmonds, *University of Chile, Chile*  
Jun Wei, *Chinese Academy of Sciences, China*

### Tools, Data, and Demonstrations Chairs

Thorsten Berger, *Chalmers Univ. of Technology, Sweden*  
Norbert Siegmund, *University of Passau, Germany*

### Doctoral Symposium Chairs

Ebrahim Bagheri, *Ryerson University, Canada*  
Li Zhang, *Beihang University, China*

### Publicity Chairs

David Benavides, *University of Sevilla, Spain*  
Leopoldo Teixeira, *Federal Univ. of Pernambuco, Brazil*  
Jiangtao Wang, *Peking University, China*

### Finance Chair

Junfeng Zhao, *Peking University, China*

### Proceedings Chair

Yingfei Xiong, *Peking University, China*

## Call For Papers

The Systems and Software Product Line Conference (SPLC) is a premier forum where researchers, practitioners, and educators can present and discuss the most recent ideas, trends, experiences, and challenges in the area of software and system product lines engineering.

SPLC 2016 will feature the following main tracks:

**Research Track:** High quality research work that uses established scientific methodologies, written using high standards of academic technical publications, i.e., original and unpublished results in all areas related to software product line engineering.

**Software Industry Track:** Challenges, innovations and solutions to concrete industrial applications of software and product line engineering tools and methodologies. These papers should have a significant software component to the research (see the Systems Engineering track otherwise).

**Systems Engineering Track:** Both research-oriented and/or industry-oriented papers, which are explicitly aimed at product lines residing primarily in the Systems Engineering space. Specifically, this track is for papers addressing product line engineering where the focus extends beyond software to other lifecycle phases (design, testing, mechanical, electrical, operations, portfolio management, manufacturing, systems modeling, simulation, etc.) and/or concerns across all stakeholder organizations. Industry or research papers focusing primarily on software product lines should be submitted to the traditional industry and research tracks.

**Vision Track:** Papers that reach out to new communities around product lines, explore unusual interdisciplinary research, synergies with other fields, or present disruptive innovations. These papers should not be traditional SPLC research papers in a shorter form.

Additionally, SPLC will feature (check [www.splc2016.net](http://www.splc2016.net) for details):

**Workshops and Tutorials:** you can submit your proposals of workshops and tutorials related to systems and software product line topics.

**Tools, Data, and Demonstrations:** an opportunity for live demonstrations of product-line tools, of substantial datasets to be shared with the community, and of practices tackling current industrial challenges.

**Doctoral Symposium:** Doctoral proposals, both early- and mid-phase, to be reviewed and commented on by a panel of experts.

Submissions should follow the ACM proceedings format (<http://www.acm.org/publications/article-templates/proceedings-template.html/>) and will be reviewed by at least three members of the SPLC 2016 program committees. The SPLC proceedings will be published by ACM in the ACM Digital Library in its International Conference Proceedings Series.

We use EasyChair (<https://easychair.org/conferences/?conf=splc2016>) to handle submissions and reviews.

Please note that the 24<sup>th</sup> International Requirements Engineering Conference (<http://re16.org>) will be the week before SPLC, Sept 12-16, also in Beijing.



September 12–16, 2016, Beijing, China.